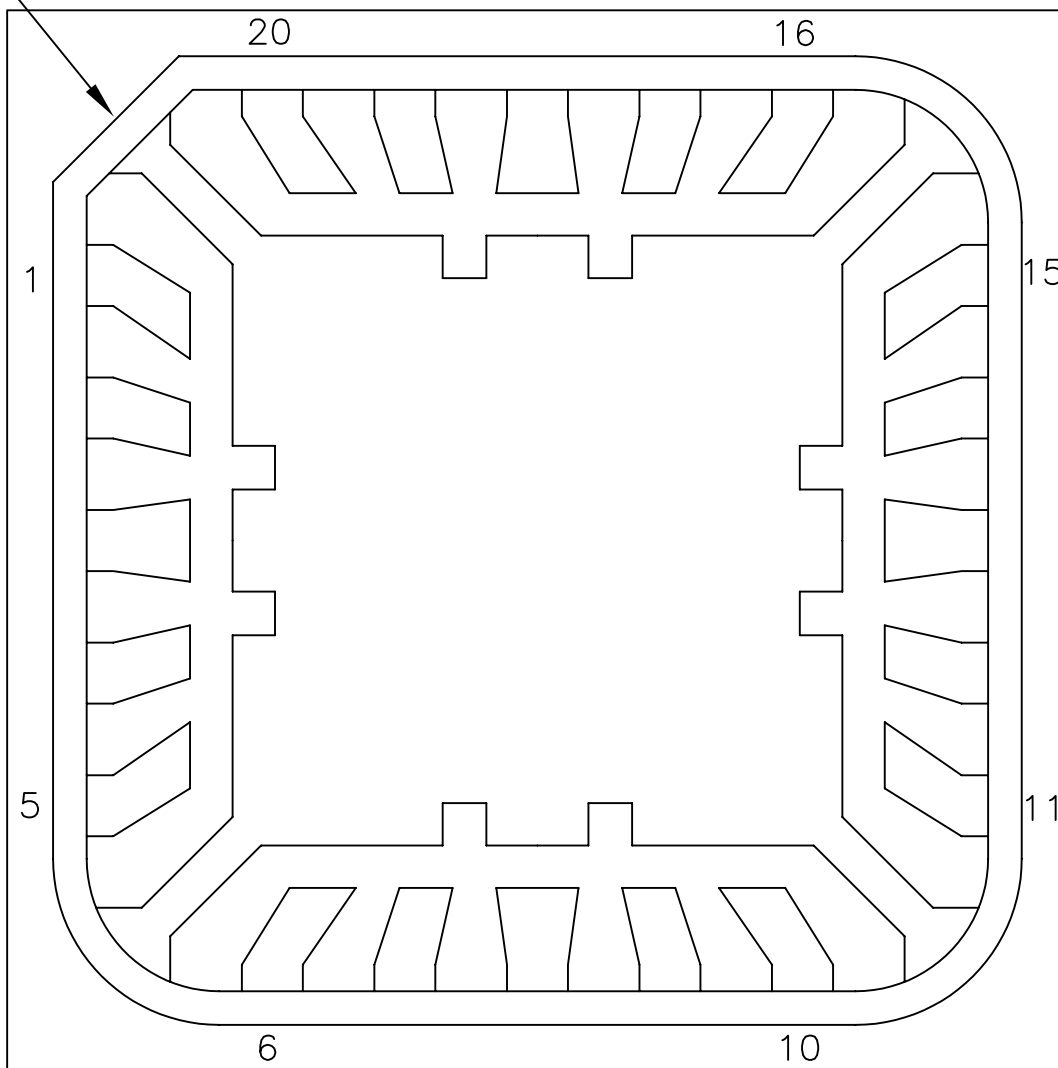


PIN #1 IDENTIFIER



DEVICE TYPE:

CUSTOMER:

WIRE TYPE/
SIZE:

DIE
SIZE:

NO. OF
WIRES:



THIRD ANGLE
PROJECTION

REVISIONS

UNLESS OTHERWISE SPECIFIED
DIMENSIONS ARE IN MILLIMETER
DO NOT SCALE DRAWING

ECN NO.	DATE	DESCRIPTION	APPROVED
10611	2/27/06	INITIAL RELEASE	D.BENANDO

DRAWN BY
W. GRIFFITTS

DATE
2/27/06

PACKAGE SIZE:
4.00mm x 4.00mm

APP BY
P. FLASKERUD

DATE
2/27/06

DIE PAD SIZE:
2.300mm x 2.300mm

SIZE
A

PART NO.
MLP4X4-20-OP-01

REV
1

SCALE 36X

CAD FILE
MLP4X4-20-OP-01-B-R1.DWG

SHEET 1 OF 1

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Open-Pak™ Technologies
www.sempac.com
568 E. WEDDELL DRIVE, SUITE 5
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PHONE: (408) 400-9002 FAX: (408) 400-9006

20 Lead 4mm x 4mm MLP
Open-Pak Bonding Diagram